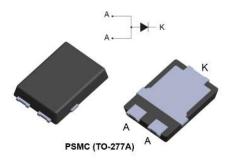


60 V power Schottky rectifier



Features

- Low profile design package typical height of 1.1 mm typ.
- · Wettable flanks for automatic visual inspection
- · High junction temperature capability
- Low Leakage current
- Avalanche capability
- ECOPACK®2 compliant

Applications

- Set-top box
- · Battery charger
- DC / DC converter
- · Notebook adapter
- · Switching diode

Description

This 60 V Schottky barrier rectifier has been optimized for use in high frequency miniature DC/DC converters, reverse battery protection, battery chargers and adaptors.

Packaged in PSMC (TO-277A), the STPS10H60SF provides a high level of performance in a compact and flat package which can withstand very high operating junction temperature.

Product status link	
STPS10H60SF	

Product summary			
Symbol Value			
I _{F(AV)}	10 A		
V _{RRM}	60 V		
T _j (max.)	175 °C		
V _F (typ.)	0.60 V		



1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified with anode terminals short-circuited)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	60	V	
I _{F(AV)}	Average forward current, δ = 0.5 square pulse T_c = 140 °C		10	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		210	Α
P _{ARM}	Repetitive peak avalanche power t_p = 10 μ s, T_j = 125 $^{\circ}$ C		145	W
T _{stg}	Storage temperature range	-65 to +175	°C	
T _j	Maximum operating junction temperature ⁽¹⁾ +			°C

^{1.} $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	rameter Typ. value	
$R_{th(j-c)}$	Junction to case	2.4	°C/W

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (anode terminals short-circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage cu	Doverse leekage current	T _j = 25 °C	$V_R = V_{RRM}$	-		20	μA
	Reverse leakage current	T _j = 125 °C		-	2	10	mA
V _F ⁽²⁾ Forward voltag		T _j = 25 °C	I _F = 5 A	-		0.65	V
	Forward voltage drop	T _j = 125 °C		-	0.515	0.58	
		T _j = 25 °C	I _F = 10 A	-		0.79	
		T _j = 125 °C		-	0.60	0.67	

^{1.} Pulse test: t_p = 5 ms, δ < 2%

To evaluate the conduction losses, use the following equation:

$$P = 0.49 \times I_{F(AV)} + 0.018 \times I_{F^{2}(RMS)}$$

For more information, please refer to the following application notes related to the power losses:

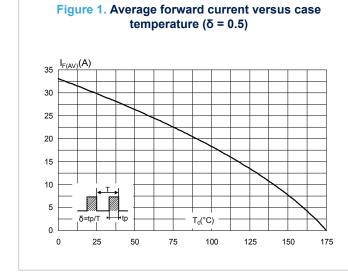
- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

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^{2.} Pulse test: t_p = 380 μ s, δ < 2%



1.1 Characteristics curves



to case versus pulse duration 1.0 0.9 0.8 0.7 0.6 0.5 0.4 0.3 0.2 0.1 $t_P(s)$ 0.0 1.E-04 1.E-03 1.E-02 1.E-01 1.E+00

Figure 2. Relative variation of thermal impedance junction

1.E+04
1.E+03
1.E+02
1.E+01
1.E+01
0 5 10 15 20 25 30 35 40 45 50 55 60

Figure 3. Reverse leakage current versus reverse voltage

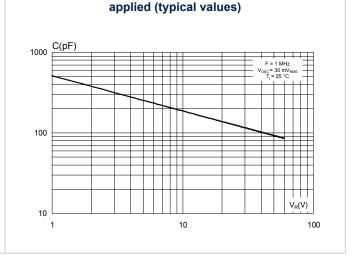
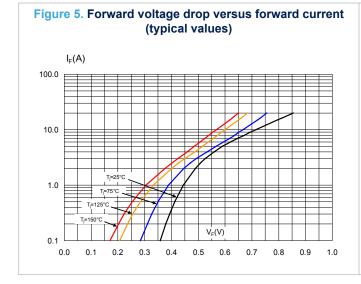


Figure 4. Junction capacitance versus reverse voltage

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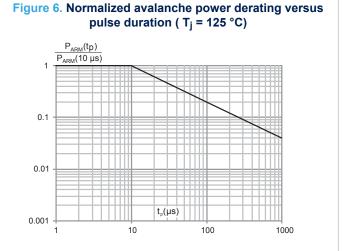
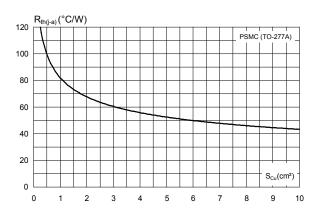


Figure 7. Thermal resistance junction to ambient versus copper surface under tab (typical values, epoxy printed board FR4, e_{Cu} = 35 μ m) (PSMC (TO-277A))



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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

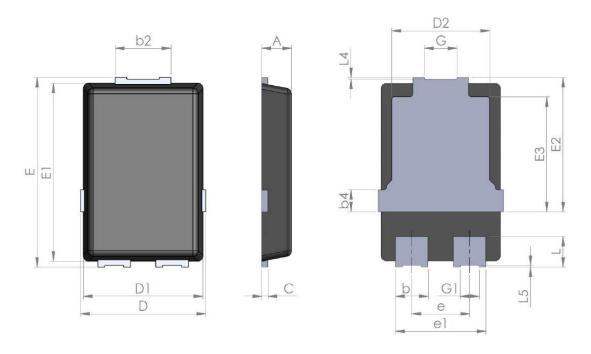
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2.1 PSMC (TO-277A) package information

- Epoxy meets UL94,V0
- Cooling method : by conduction (C)

Figure 8. PSMC (TO-277A) package outline



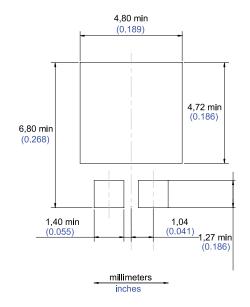
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Table 4. PSMC (TO-277A) package mechanical data

	Dimensions						
Ref.	Millimeters			Inches (for reference only)			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	1.00	1.10	1.20	0.039	0.043	0.047	
b	1.05	1.20	1.35	0.041	0.047	0.053	
b2	1.90	2.05	2.20	0.075	0.081	0.087	
b4		0.75			0.029		
С	0.15	0.23	0.40	0.006	0.009	0.016	
D	4.45	4.60	4.75	0.175	0.181	0.187	
D1	4.25	4.40	4.45	0.167	0.173	0.175	
D2	3.40	3.60	3.70	0.134	0.142	0.146	
E	6.35	6.50	6.65	0.250	0.256	0.262	
E1	6.05	6.10	6.15	0.238	0.240	0.242	
E2	4.50	4.60	4.70	0.177	0.181	0.185	
E3		3.94			1.55		
е		2.13			0.084		
e1		3.33			0.131		
G		1.20			0.047		
G1		0.70			0.027		
L	0.90	1.05	1.24	0.035	0.041	0.049	
L4	0.02			0.0008			
L5	0.02			0.0008			

Figure 9. PSMC (TO-277A) package footprint in mm (in inches)



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3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS10H60SF	PS10H60	PSMC (TO-277A)	90 mg	6000	Tape and Reel

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Revision history

Table 6. Document revision history

Date	Version	Changes	
24-Jul-2018	1	Initial release.	
07-Nov-2018	2	Updated Table 5. Ordering information.	

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